

BladeCore-M54C User Manual

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Table of Contents

1. Introduction
2. General Specifications
3. Electrical Characteristics
4. Microcontroller
5. Memory Subsystem
6. CAN Interface
7. USB Interface
8. Power Management
9. M.2 Connector Pinout
10. Onboard Peripherals
11. Power-Up Sequencing
12. Getting Started – Software
13. Programming Guide
14. Code Examples
15. Design Considerations for Carrier Boards
16. Mechanical Specifications
17. Absolute Maximum Ratings
18. Revision History

1. Introduction

BladeCore-M54C is a compact, modular microcontroller card built around the **RP2354B** (ARM Cortex-M33, dual-core) combined with an **MCP2515 CAN controller** and **TCAN1044AVDRBRQ1 CAN transceiver**. The module uses an **M.2 2980 M-Key** form factor (29 mm wide, 80 mm long) with a standard M-Key edge connector at a non-standard board width, making it suitable for embedding into carrier boards or systems that provide power and I/O connectivity through the M.2 edge connector.

Key Features

- RP2354B dual-core ARM Cortex-M33 microcontroller
- 2 MB integrated flash + 16 MB external QSPI flash
- 256 kbit external I2C EEPROM with 200+ year data retention
- CAN 2.0B via MCP2515 (SPI-attached) + TCAN1044A transceiver
- Dual-path USB 2.0 with automatic source selection (M.2 + USB-C)
- 31 GPIO pins + 6 ADC channels routed to M.2 edge connector
- Onboard 3.3 V LDO with power-good signaling
- Defined power-up sequencing
- Onboard heartbeat LED (PWM-capable)
- SWD debug interface

BladeCore Series

BladeCore-M54C belongs to the BladeCore modular controller series:

Module	MCU	Primary Interface
BladeCore-M40	RP2040	–
BladeCore-M40E	RP2040	Ethernet
BladeCore-M40C	RP2040	CAN
BladeCore-M54	RP2354B	–
BladeCore-M54E	RP2354B	Ethernet
BladeCore-M54C	RP2354B	CAN

Naming convention: M40 = RP2040-based, M54 = RP2354B-based. Suffix E = Ethernet, C = CAN, no suffix = base module.

2. General Specifications

Parameter	Value
Microcontroller	RP2354B (ARM Cortex-M33, dual core)
Package	QFN-80-EP (10 x 10 mm)
System Clock	150 MHz, overclock possible (Tested max is 200MHz)
External Crystal	12 MHz, 10 pF load
Integrated Flash	2 MB (internal to MCU)
External Flash (QSPI)	16 MB (W25Q128JVPIQ, 133 MHz)
External EEPROM (I2C)	256 kbit (AT24C256C, 400 kHz)
CAN	CAN 2.0B, MCP2515 (SPI) + TCAN1044A transceiver
USB	USB 2.0, dual path (M.2 + USB-C)
GPIO (M.2 connector)	31 digital I/O pins
ADC Channels (M.2)	6 channels (12-bit, GPIO40–GPIO45)
Onboard ADC Channels	2 (VBUS sense, 3.0 V reference)
Operating Voltage (I/O)	3.3 V
Form Factor	M.2 2980 M-Key
PCB Layers	6

3. Electrical Characteristics

3.1 Recommended Operating Conditions

Parameter	Symbol	Min	Typical	Max	Unit
Supply Voltage (5 V in)	VIN	4.75	5.0	5.5	V
Supply Voltage (3.3 V)	VCC	3.0	3.3	3.6	V
USB VBUS Voltage	VBUS	4.75	5.0	5.25	V
Operating Temperature	TA	-20	25	70	degC
I/O Logic Level (High)	VIH	2.0	–	3.3	V
I/O Logic Level (Low)	VIL	0	–	0.8	V

3.2 RP2354B Core Parameters

Parameter	Value
Core Voltage	1.1 V (internal)
GPIO Output Drive	2 / 4 / 8 / 12 mA
GPIO Input Hysteresis	Schmitt trigger
Internal Pull-Up/Down Resistance	50–80 kOhm
ADC Resolution	12 bits
ADC Reference Voltage	3.3 V (AVDD)

3.3 Power Consumption (Typical)

Condition	Current (3.3 V)	Notes
MCU idle, CAN off	~15 mA	RP2354B in normal idle
MCU active, CAN off	~40 mA	Both cores running
MCU active, CAN active	~55 mA	MCP2515 + TCAN1044A active
MCU dormant (sleep)	<1 mA	Deep sleep, all peripherals off

Note: The above values are approximate. Actual consumption depends on clock frequency, active peripherals, GPIO loading, and CAN bus traffic. Consult the RP2354B, MCP2515, and TCAN1044A datasheets for detailed characterization.

3.4 LDO Regulator (TPS74801)

Parameter	Symbol	Min	Typical	Max	Unit
Input Voltage	VIN	1.1	5.0	5.5	V
Output Voltage	VOUT	–	3.3	–	V
Max Output Current	IOUT	–	–	1.5	A
Dropout Voltage	VDO	–	110	300	mV
Output Voltage Accuracy	–	–	+/-1	–	%
Thermal Shutdown	–	–	160	–	degC

3.5 Voltage Reference (LM4040B30FTA)

Parameter	Value
Reference Voltage	3.000 V
Tolerance	+/-0.1%
Package	SOT-23
Connected To	ADC7 (GPIO47) via 10K-10K divider

4. Microcontroller

4.1 RP2354B Overview

The RP2354B is a dual-core ARM Cortex-M33 microcontroller from Raspberry Pi Ltd. It features hardware floating-point, DSP extensions, and the RP2-series PIO (Programmable I/O) state machines.

Feature	Specification
Architecture	ARM Cortex-M33 (ARMv8-M)
Cores	2
Max Clock Speed	150 MHz
FPU	Single-precision hardware FPU
DSP	Yes (ARMv8-M DSP extension)
PIO State Machines	3 PIO blocks (PIO0, PIO1, PIO2)
DMA Channels	16
Timers	2 hardware timers
PWM Channels	24 (12 slices x 2 channels)
UART	2
SPI	2
I2C	2
USB	1 (USB 1.1 Host/Device)
ADC	12-bit SAR, 8 channels (+ temp)
Internal Flash	2 MB
SRAM	520 KB
Debug	SWD (Serial Wire Debug)
Package	QFN-80-EP (10 x 10 mm)

4.2 Clock Configuration

- **External Crystal:** 12 MHz (X3225 footprint), 10 pF load capacitance
- **System PLL:** Configurable up to 150 MHz system clock
- **USB PLL:** 48 MHz (required for USB operation)

4.3 GPIO Allocation on BladeCore-M54C

GPIO Range	Count	Assignment
GPIO0-27	28	Routed to M.2 edge connector (user I/O)

GPIO Range	Count	Assignment
GPIO28–31	4	MCP2515 CAN SPI1 (MISO, CS, SCK, MOSI)
GPIO32–33	2	I2C0 – EEPROM (SDA, SCL)
GPIO34	1	MCP2515 hardware reset
GPIO35	1	MCP2515 interrupt (active low)
GPIO36	1	Onboard heartbeat LED (blue, PWM)
GPIO37–39	3	Routed to M.2 edge connector (user I/O)
GPIO40–45	6	Routed to M.2 as ADC0–ADC5
GPIO46	1	Onboard ADC6 – USB VBUS sense
GPIO47	1	Onboard ADC7 – 3.0 V reference monitor

Total GPIO available on M.2 connector: 37 (31 digital + 6 ADC-capable)

Warning: GPIO28–31 are dedicated to the MCP2515 CAN controller and are NOT available for user applications. GPIO34 and GPIO35 are used for MCP2515 reset and interrupt respectively.

5. Memory Subsystem

5.1 Integrated Flash

- Built into the RP2354B
- Capacity: 2 MB
- Used for program storage and execution (XIP – execute in place)

5.2 External QSPI Flash (W25Q128JVPIQ)

Parameter	Value
Part Number	W25Q128JVPIQ (Winbond)
Capacity	16 MB (128 Mbit)
Interface	Quad SPI (QSPI)
Max Clock	133 MHz
Package	8-WSON (6 x 5 mm)
Erase Granularity	4 KB sector / 32 KB block / 64 KB block
Write Granularity	256 bytes (page program)
Endurance	100,000 erase cycles per sector

The external flash is connected to the RP2354B's dedicated QSPI interface and can be used for additional program storage, file systems (e.g., LittleFS), or data logging.

5.3 External EEPROM (AT24C256C)

Parameter	Value
Part Number	AT24C256C-XHL-T (Microchip)
Capacity	256 kbit (32,768 x 8 bytes)
Interface	I2C (shared with I2C0)
I2C Address	0x50 (A0 = A1 = GND)
Max Clock	400 kHz (Fast mode)
Write Page Size	64 bytes
Write Cycle Time	5 ms (max)
Endurance	1,000,000 write cycles
Data Retention	200+ years
Package	8-TSSOP
Pull-Up Resistors	4.7 kOhm on SDA and SCL

The EEPROM is connected to I2C0 on GPIO32/33, which are internal to the module and not routed to the M.2 connector. When I2C0 is used on a different pin pair via the M.2 edge connector, it operates on a physically separate bus - address 0x50 is fully available on the carrier board side. The EEPROM is ideal for storing configuration data, calibration values, serial numbers, or small persistent datasets.

6. CAN Interface

6.1 MCP2515 CAN Controller Overview

Parameter	Value
Part Number	MCP2515T-I/ML (Microchip)
Standard	CAN 2.0B (active)
Message Buffers	3 TX, 2 RX (with 6 acceptance filters)
Interface to MCU	SPI (up to 10 MHz)
Crystal	16 MHz, 8 pF load
Package	QFN-20 (4 x 4 mm)
Operating Temp	-40 degC to +85 degC

The MCP2515 is a stand-alone CAN controller with an SPI interface. It implements the CAN 2.0B protocol, supporting both standard (11-bit) and extended (29-bit) identifiers. Message filtering and buffering are handled in hardware.

6.2 TCAN1044A CAN Transceiver

Parameter	Value
Part Number	TCAN1044AVDRBRQ1 (Texas Instruments)
Standard	CAN 2.0 / CAN FD (physical layer)
Data Rate	Up to 5 Mbps (CAN FD capable)
Supply Voltage	3.3 V
Bus Fault Protection	+/-58 V
Package	HVSON-8 (3 x 3 mm)
Operating Temp	-40 degC to +125 degC
Automotive Qualified	Yes (AEC-Q100)

The TCAN1044A converts the MCP2515 logic-level TX/RX signals to differential CAN bus levels (CANH / CANL).

6.3 SPI Connection to MCU

Signal	GPIO	Direction (MCU view)
MISO	GPIO28	Input
CS	GPIO29	Output
SCK	GPIO30	Output
MOSI	GPIO31	Output

These GPIO are used internally and are NOT available on the M.2 connector for user applications.

Control	GPIO	Function
RST	GPIO34	Hardware reset (active low)
INT	GPIO35	Interrupt output (active low)

SPI Configuration: - SPI Instance: SPI1 - Baudrate: 10 MHz (default in CONFIG.h) - Mode: SPI Mode 0 (CPOL=0, CPHA=0)

6.4 CAN Bus Signals on M.2 Connector

M.2 Pin	Signal	Description
28	CAN_P	CAN High (CANH)
30	CAN_N	CAN Low (CANL)

The carrier board connects these pins to the CAN bus through an appropriate connector (e.g., screw terminal, DB-9, or pin header).

6.5 Bus Termination

The module includes onboard split termination:

- R35: 60.4 Ohm (CANH to midpoint)
- R36: 60.4 Ohm (CANL to midpoint)
- Total differential termination: ~120 Ohm (standard CAN bus termination)

Note: The onboard termination is suitable when the module is at one end of the CAN bus. For mid-bus installations, the termination resistors should be removed (depopulated) and termination provided at both physical ends of the bus.

6.6 Signal Conditioning

- **Common Mode Choke:** ACT1210D-101-2P-TL00 (TDK), 100 uH at 100 kHz, 1210 package. Suppresses common-mode noise on the CAN differential pair.
- **Coupling Capacitors:** C34, C35 (47 pF, optional / DNI). May improve EMC performance but can degrade signal integrity at higher bit rates – evaluate on the target application.

6.7 ESD Protection

- **Device:** PESD2CANFD24V-UX (Nexperia)
- **Rating:** 24 V, dual-channel ESD protection for CAN FD bus lines
- **Package:** SOC-75 (SOT-523)

6.8 Reference Crystal

- Frequency: 16 MHz
- Load Capacitance: 8 pF
- Package: SMD 2016 (2.0 x 1.6 mm)

7. USB Interface

7.1 Dual-Path Architecture

BladeCore-M54C provides two physical USB connection paths:

1. **M.2 edge connector USB** – for connection through the carrier board
2. **Onboard USB-C connector** – for direct access during development or provisioning

A **FSUSB42MUX** (OnSemi) USB 2.0 multiplexer automatically selects the active path:

Condition	Active USB Path
No USB-C cable connected	M.2 edge connector
USB-C cable connected	Onboard USB-C

This selection is automatic – no firmware intervention or manual jumper configuration is required.

7.2 M.2 USB Signals

M.2 Pin	Signal	Description
69	USB_D+	USB Data +
71	USB_D-	USB Data -
72, 74	VBUS	USB VBUS (5V)
75	VBUS	USB VBUS (5V)

7.3 USB-C Connector

- Type: USB-TYPE-C-018 receptacle
- Supports plugging/unplugging during operation (hot-swap)
- CC resistors onboard for proper USB-C enumeration
- ESD protection: SP0503BAHTG on data lines

7.4 USB VBUS Sensing

The USB VBUS voltage is monitored via GPIO46 (ADC6) through a resistive voltage divider:

- Divider: 5.1 kOhm / 5.1 kOhm
- ADC input voltage at 5.0 V VBUS: ~2.5 V
- Formula: $VBUS = ADC_reading * (3.0 / 4096) * 2$

This allows firmware to detect whether USB power is present and measure the actual VBUS voltage.

8. Power Management

8.1 Power Input Options

BladeCore-M54C can be powered through four paths:

Source	Input Pins	Path
M.2 5 V	Pins 14, 16 (+5V INPUT)	5 V -> TPS74801 LDO -> 3.3 V rail
M.2 VBUS	Pins 72, 74, 75 (VBUS)	VBUS -> TPS74801 LDO -> 3.3 V rail
Onboard USB-C	USB-C connector	VBUS -> TPS74801 LDO -> 3.3 V rail
External 3.3 V	Pins 10, 12 (+3.3V OUTPUT)	Direct to 3.3 V rail (LDO bypassed)

8.2 3.3 V Output to Carrier Board

When the module is powered from 5 V (pins 14/16, VBUS, or USB-C), the regulated 3.3 V rail is provided back to the carrier board on M.2 pins 10 and 12 (+3.3V OUTPUT). The LDO can supply **1.5 A** total. Each M.2 contact is rated for 0.5 A, so with two pins the connector limits the carrier board output to **1 A**. The remaining 0.5 A is the module's own budget, of which ~55 mA is typically consumed (with CAN active).

When the module is powered externally at 3.3 V on these same pins, the carrier board supplies both the module and itself – the LDO is not active in this mode.

8.3 Voltage Regulator – TPS74801DRCT

Parameter	Value
Type	Low-Dropout (LDO)
Output Voltage	3.3 V
Max Output Current	1.5 A
Dropout Voltage	110 mV typical
Package	VSON-10-1EP (3x3 mm)
Enable Pin	VEN (active high)
Power-Good Output	PGOOD (open drain)

8.4 Power-Good Indication

The LDO provides a PGOOD signal that goes high once the output voltage reaches regulation. This signal is buffered through an **SN74LVC1G97QDCKRQ1** logic gate before driving an onboard green LED (visual indicator).

8.5 Onboard Voltage Reference

A precision **LM4040B30FTA** (3.000 V, +/-0.1%) voltage reference is connected to GPIO47 (ADC7) through a 10K / 10K voltage divider. This enables: - ADC calibration at runtime (known reference voltage) - Detection of supply rail drift - High-accuracy analog measurements

To calibrate the ADC:

Expected ADC reading for 3.0V reference through 10K/10K divider:

$$V_{ADC} = 3.0 / 2 = 1.5 \text{ V}$$

$$\text{Expected ADC code} = 1.5 / 3.0 * 4096 = \sim 2048$$

$$\text{Calibration factor} = 2048 / \text{actual_adc_reading}$$

Apply this factor to all subsequent ADC readings.

9. M.2 Connector Pinout

9.1 Left Side (Odd Pins)

Pin	Signal	GPIO	Alternate Functions
1	GND	–	Ground
3	GPIO24	GPIO24	SPI0 TX, UART1 RTS, I2C1 SCL, PWM3 B, PIO0/1/2
5	GPIO23	GPIO23	SPI0 TX, UART1 RTS, I2C1 SCL, PWM3 B, PIO0/1/2
7	GPIO22	GPIO22	SPI0 SCK, UART1 CTS, I2C1 SDA, PWM3 A, PIO0/1/2
9	GPIO21	GPIO21	SPI0 CSn, UART1 RX, I2C0 SCL, PWM2 B, PIO0/1/2
11	GND	–	Ground
13	GPIO20	GPIO20	SPI0 RX, UART1 TX, I2C0 SDA, PWM2 A, PIO0/1/2
15	GPIO19	GPIO19	SPI0 TX, UART0 RTS, I2C1 SCL, PWM1 B, QMI CS1n
17	GPIO18	GPIO18	SPI0 SCK, UART0 CTS, I2C1 SDA, PWM1 A, PIO0/1/2
19	GPIO17	GPIO17	SPI0 CSn, UART0 RX, I2C0 SCL, PWM0 B, PIO0/1/2
21	GPIO16	GPIO16	SPI0 RX, UART0 TX, I2C0 SDA, PWM0 A, PIO0/1/2
23	GND	–	Ground
25	GPIO15	GPIO15	SPI1 TX, UART0 RTS, I2C1 SCL, PWM7 B, PIO0/1/2
27	GPIO14	GPIO14	SPI1 SCK, UART0 CTS, I2C1 SDA, PWM7 A, PIO0/1/2
29	GPIO13	GPIO13	SPI1 CSn, UART0 RX, I2C0 SCL, PWM6 B, PIO0/1/2
31	GPIO12	GPIO12	SPI1 RX, UART0 TX, I2C0 SDA, PWM6 A, PIO0/1/2
33	GPIO11	GPIO11	SPI1 TX, UART1 RTS, I2C1 SCL, PWM5 B, PIO0/1/2
35	GPIO10	GPIO10	SPI1 SCK, UART1 CTS, I2C1 SDA, PWM5 A, PIO0/1/2
37	GPIO9	GPIO9	SPI1 CSn, UART1 RX, I2C0 SCL, PWM4 B, PIO0/1/2
39	GPIO8	GPIO8	SPI1 RX, UART1 TX, I2C0 SDA, PWM4 A, QMI CS1n
41	GND	–	Ground
43	GPIO7	GPIO7	SPI0 TX, UART1 RTS, I2C1 SCL, PWM3 B, PIO0/1/2
45	GPIO6	GPIO6	SPI0 SCK, UART1 CTS, I2C1 SDA, PWM3 A, PIO0/1/2
47	GPIO5	GPIO5	SPI0 CSn, UART1 RX, I2C0 SCL, PWM2 B, PIO0/1/2
49	GPIO4	GPIO4	SPI0 RX, UART1 TX, I2C0 SDA, PWM2 A, PIO0/1/2
51	GPIO3	GPIO3	SPI0 TX, UART0 RTS, I2C1 SCL, PWM1 B, PIO0/1/2
53	GPIO2	GPIO2	SPI0 SCK, UART0 CTS, I2C1 SDA, PWM1 A, PIO0/1/2
55	GPIO1	GPIO1	SPI0 CSn, UART0 RX, I2C0 SCL, PWM0 B, TRACECLK
57	GPIO0	GPIO0	SPI0 RX, UART0 TX, I2C0 SDA, PWM0 A, QMI CS1n
67	GND	–	Ground
69	USB_D+	–	USB Data Plus
71	USB_D-	–	USB Data Minus
73	GND	–	Ground
75	VBUS	–	USB VBUS (5 V)

9.2 Right Side (Even Pins)

Pin	Signal	GPIO	Notes
2	GND	–	Ground
4	GPIO27	GPIO27	SPI1 TX, UART1 RTS, I2C1 SCL, PWM5 B
6	GPIO26	GPIO26	SPI1 SCK, UART1 CTS, I2C1 SDA, PWM5 A
8	GPIO25	GPIO25	SPI1 CSn, UART1 RX, I2C0 SCL, PWM4 B
10	+3.3V OUTPUT	–	3.3 V LDO output / external 3.3 V input
12	+3.3V OUTPUT	–	3.3 V LDO output / external 3.3 V input
14	+5V INPUT	–	5 V power input to module
16	+5V INPUT	–	5 V power input to module
18	GND	–	Ground
20	GND	–	Ground
22	GND	–	Ground
24	GND	–	Ground
26	GND	–	Ground
28	CAN_P	–	CAN High (CANH)
30	CAN_N	–	CAN Low (CANL)
32	GND	–	Ground
34	GPIO37	GPIO37	SPI0 CSn, UART1 RX, I2C0 SCL, PWM2 B, PIO0/1/2
36	GPIO38	GPIO38	SPI0 RX, UART1 TX, I2C0 SDA, PWM3 A, PIO0/1/2
38	GND	–	Ground
40	GPIO39	GPIO39	SPI0 TX, UART1 RTS, I2C1 SCL, PWM3 B, PIO0/1/2
42	GND	–	Ground
44	GND	–	Ground
46	ADC0/GPIO40	GPIO40	Analog/digital, PWM8 A, SPI1, UART1, I2C0
48	ADC1/GPIO41	GPIO41	Analog/digital, PWM8 B, SPI1, UART1, I2C0
50	ADC2/GPIO42	GPIO42	Analog/digital, PWM9 A, SPI1, UART1, I2C1
52	ADC3/GPIO43	GPIO43	Analog/digital, PWM9 B, SPI1, UART1, I2C1
54	ADC4/GPIO44	GPIO44	Analog/digital, PWM10 A, SPI1, UART0, I2C0
56	ADC5/GPIO45	GPIO45	Analog/digital, PWM10 B, SPI1, UART0, I2C0
58	GND	–	Ground
68	GND	–	Ground
70	GND	–	Ground
72	VBUS	–	USB VBUS (5 V)
74	VBUS	–	USB VBUS (5 V)
SH1	SHIELD	–	Shield / Ground

9.3 Important Notes

- **SPI1** (GPIO8–15, GPIO25–31, GPIO40–45) overlaps with both user-accessible pins and the onboard MCP2515. GPIO28–31 are dedicated to the MCP2515 and are **not** available on the M.2 connector. User code must avoid configuring GPIO28–31 for other purposes.
- **I2C0** can be used on any M.2-accessible GPIO with an I2C0 alternate function. The onboard EEPROM uses GPIO32–33, which are not wired to the M.2 connector, so the carrier board's I2C0 bus is physically independent.
- **CAN bus** signals (CAN_P, CAN_N) on M.2 pins 28 and 30 are directly from the TCAN1044A transceiver – these are not GPIO-controlled.

10. Onboard Peripherals

10.1 Heartbeat LED

Parameter	Value
GPIO	GPIO36
Color	Blue
Package	0402 (1005 Metric)
Series Resistor	1000 Ohm
PWM Slice	Slice 2, Channel A
PWM Frequency	1000 Hz (configurable)

The heartbeat LED is intended as a visual “alive” indicator. It can be driven with simple digital on/off or with hardware PWM for breathing/fading effects.

10.2 Reset Buttons

Two tactile switches (B3U-1000P, Omron) are provided on the board for manual reset and boot-mode selection.

10.3 Status LEDs

LED	Color	Designator	Function
+5V	Green	D10	Connected to VIN_PWR; active when VBUS or +5V is present
PGOOD	Green	D6	Driven via SN74LVC1G97 buffer; active when 3.3V is OK
VBUS	Green	D11	Monitors onboard USB-C VBUS
Heartbeat	Blue	D3	Connected to MCU GPIO36; PWM breathing indicator

10.4 ESD Protection

Device	Protection
SP0503BAHTG	USB data line ESD clamping
RCLAMP0582BQTCT	General I/O ESD clamping
PESD2CANFD24V-UX	CAN bus line ESD clamping

11. Power-Up Sequencing

The board follows a defined power-up sequence with the following timeline:

Step	Event	Time (cumulative)
1	VIN applied (5.0 V)	0 ms
2	VEN asserted (TPS74801 enables)	0 ms
3	VOOUT (3.3 V) reaches regulation	~4 ms (soft-start)
4	PGOOD asserts (power-good valid)	~4 ms
5	RP2354B 3.3 V rail stable	~4 ms
6	RP2354B 1.1 V core valid (POR)	~4.01 ms
7	RP2354B ready for execution	~4.09 ms
8	MCP2515 ready after reset	~4.13 ms

Note: The MCP2515 requires a minimum 2 us reset pulse width. After deasserting the reset pin, the oscillator start-up time depends on the 16 MHz crystal – typically under 1 ms. Firmware should wait at least 1 ms after releasing the MCP2515 reset before attempting SPI communication.

12. Getting Started – Software

12.1 Prerequisites

- **Raspberry Pi Pico SDK** version 2.2.0 or later
- **ARM GCC Toolchain** version 14.2 or later
- **CMake** version 3.13 or later
- **Picotool** version 2.2.0 or later (for UF2 flashing)
- A USB cable (USB-C or via carrier board M.2 connection)

12.2 Environment Setup (Windows)

1. Install the Raspberry Pi Pico VS Code Extension which automatically installs and manages the SDK, toolchain, and picotool.
2. Alternatively, install manually:

```
# Install Pico SDK
git clone https://github.com/raspberrypi/pico-sdk.git
cd pico-sdk
git checkout 2.2.0
git submodule update --init

# Set environment variable
set PICO_SDK_PATH=C:\path\to\pico-sdk
```

12.3 Building the Heartbeat Example

```
cd src/Software/Heartbeat
```

```
mkdir build
cd build
```

```
cmake -G "Ninja" ..
ninja
```

This produces `Heartbeat.uf2` in the build directory.

12.4 Flashing Firmware

1. Hold the BOOTSEL button on the RP2354B while connecting USB (or pressing reset).
2. The board enumerates as a USB mass storage device (RP2350 drive).
3. Copy the `.uf2` file to the drive:

```
copy Heartbeat.uf2 E:\
```

(Replace `E:\` with the actual drive letter.)

4. The board automatically reboots and begins executing.

Alternatively, use picotool:

```
picotool load Heartbeat.uf2
picotool reboot
```

12.5 Serial Monitor (USB CDC)

The Heartbeat example enables USB stdio output. Connect a terminal at any baud rate (USB CDC is rate-independent):

```
# Using PuTTY, Tera Term, or any serial monitor
# Select the COM port assigned to the Pico
```

13. Programming Guide

13.1 Pin Configuration Header

All pin assignments are centralized in CONFIG.h. Always use these definitions instead of hardcoding GPIO numbers:

```
#include "CONFIG.h"

// CAN SPI
PIN_CAN_MISO    // GPIO28 - SPI1 RX
PIN_CAN_CS      // GPIO29 - SPI1 CSn
PIN_CAN_SCK     // GPIO30 - SPI1 SCK
PIN_CAN_MOSI    // GPIO31 - SPI1 TX

// I2C EEPROM
PIN_I2C0_SDA    // GPIO32
PIN_I2C0_SCL    // GPIO33

// CAN control
PIN_CAN_RST     // GPIO34 - MCP2515 reset (active Low)
PIN_CAN_INT     // GPIO35 - MCP2515 interrupt (active Low)

// Heartbeat LED
PIN_HEARTBEAT   // GPIO36

// ADC
PIN_ADC_VUSB    // GPIO46 / ADC6 - USB VBUS sense
PIN_ADC_VREF    // GPIO47 / ADC7 - Voltage reference
```

13.2 SPI1 – CAN Controller (MCP2515)

```
#include "hardware/spi.h"
#include "CONFIG.h"

void mcp2515_spi_init(void) {
    spi_init(CAN_SPI_INSTANCE, CAN_SPI_BAUDRATE);

    gpio_set_function(PIN_CAN_MISO, GPIO_FUNC_SPI);
    gpio_set_function(PIN_CAN_MOSI, GPIO_FUNC_SPI);
    gpio_set_function(PIN_CAN_SCK, GPIO_FUNC_SPI);

    // CS is managed manually (active Low)
    gpio_init(PIN_CAN_CS);
    gpio_set_dir(PIN_CAN_CS, GPIO_OUT);
    gpio_put(PIN_CAN_CS, 1); // Deselect

    // Reset pin
    gpio_init(PIN_CAN_RST);
    gpio_set_dir(PIN_CAN_RST, GPIO_OUT);
    gpio_put(PIN_CAN_RST, 1); // Not in reset

    // Interrupt pin
    gpio_init(PIN_CAN_INT);
    gpio_set_dir(PIN_CAN_INT, GPIO_IN);
    gpio_pull_up(PIN_CAN_INT);
}

void mcp2515_reset(void) {
    gpio_put(PIN_CAN_RST, 0);
    sleep_us(10); // Hold reset for at least 2 us
    gpio_put(PIN_CAN_RST, 1);
}
```

```

    sleep_ms(1);          // Wait for oscillator start-up
}

// MCP2515 SPI instruction: RESET
void mcp2515_soft_reset(void) {
    uint8_t cmd = 0xC0; // RESET instruction
    gpio_put(PIN_CAN_CS, 0);
    spi_write_blocking(CAN_SPI_INSTANCE, &cmd, 1);
    gpio_put(PIN_CAN_CS, 1);
    sleep_ms(1);
}

// MCP2515 SPI instruction: READ register
uint8_t mcp2515_read_reg(uint8_t addr) {
    uint8_t tx[2] = {0x03, addr}; // READ instruction + address
    uint8_t rx = 0;
    gpio_put(PIN_CAN_CS, 0);
    spi_write_blocking(CAN_SPI_INSTANCE, tx, 2);
    spi_read_blocking(CAN_SPI_INSTANCE, 0x00, &rx, 1);
    gpio_put(PIN_CAN_CS, 1);
    return rx;
}

// MCP2515 SPI instruction: WRITE register
void mcp2515_write_reg(uint8_t addr, uint8_t value) {
    uint8_t tx[3] = {0x02, addr, value}; // WRITE instruction + address + data
    gpio_put(PIN_CAN_CS, 0);
    spi_write_blocking(CAN_SPI_INSTANCE, tx, 3);
    gpio_put(PIN_CAN_CS, 1);
}

// MCP2515 SPI instruction: BIT MODIFY register
void mcp2515_bit_modify(uint8_t addr, uint8_t mask, uint8_t value) {
    uint8_t tx[4] = {0x05, addr, mask, value};
    gpio_put(PIN_CAN_CS, 0);
    spi_write_blocking(CAN_SPI_INSTANCE, tx, 4);
    gpio_put(PIN_CAN_CS, 1);
}

```

13.3 I2C0 – EEPROM (AT24C256)

```

#include "hardware/i2c.h"
#include "CONFIG.h"

void eeprom_init(void) {
    i2c_init(EEPROM_I2C_INSTANCE, EEPROM_I2C_BAUDRATE);
    gpio_set_function(PIN_I2C0_SDA, GPIO_FUNC_I2C);
    gpio_set_function(PIN_I2C0_SCL, GPIO_FUNC_I2C);
    // External 4.7K pull-ups are on the board -- no internal pull-ups needed
}

// Write up to 64 bytes (one EEPROM page) at a time
int eeprom_write(uint16_t mem_addr, const uint8_t *data, size_t len) {
    uint8_t buf[66]; // 2 address bytes + 64 data bytes max
    buf[0] = (uint8_t)(mem_addr >> 8);
    buf[1] = (uint8_t)(mem_addr & 0xFF);

    if (len > 64) len = 64;
    for (size_t i = 0; i < len; i++) {

```

```

    buf[2 + i] = data[i];
}

int ret = i2c_write_blocking(EEPROM_I2C_INSTANCE, EEPROM_I2C_ADDR,
    buf, 2 + len, false);
sleep_ms(5); // Wait for write cycle to complete
return ret;
}

// Read arbitrary number of bytes
int eeprom_read(uint16_t mem_addr, uint8_t *data, size_t len) {
    uint8_t addr_buf[2];
    addr_buf[0] = (uint8_t)(mem_addr >> 8);
    addr_buf[1] = (uint8_t)(mem_addr & 0xFF);

    int ret = i2c_write_blocking(EEPROM_I2C_INSTANCE, EEPROM_I2C_ADDR,
        addr_buf, 2, true); // No stop

    if (ret < 0) return ret;

    return i2c_read_blocking(EEPROM_I2C_INSTANCE, EEPROM_I2C_ADDR,
        data, len, false);
}

```

13.4 ADC – Voltage Monitoring

```

#include "hardware/adc.h"
#include "CONFIG.h"

void adc_monitoring_init(void) {
    adc_init();
    adc_gpio_init(PIN_ADC_VUSB); // GPIO46 / ADC6
    adc_gpio_init(PIN_ADC_VREF); // GPIO47 / ADC7
}

// Read USB VBUS voltage (5V nominal)
float read_vbus_voltage(void) {
    adc_select_input(6); // ADC6 = GPIO46
    adc_read(); // Throwaway sample after channel switch
    uint16_t raw = adc_read();
    // 5.1K / 5.1K divider, factor = 2
    return (float)raw * 3.0f / 4096.0f * 2.0f;
}

// Read precision voltage reference (3.0V nominal)
float read_vref(void) {
    adc_select_input(7); // ADC7 = GPIO47
    adc_read(); // Throwaway sample after channel switch
    uint16_t raw = adc_read();
    // 10K / 10K divider, factor = 2
    return (float)raw * 3.0f / 4096.0f * 2.0f;
}

// Calculate ADC calibration factor using known reference
float get_adc_calibration_factor(void) {
    adc_select_input(7);
    adc_read(); // Throwaway sample after channel switch
    uint16_t raw = adc_read();
    float measured = (float)raw * 3.0f / 4096.0f * 2.0f;
    return 3.0f / measured; // Ratio of known vs measured
}

```

```
}
```

13.5 PWM – Heartbeat LED

```
#include "hardware/pwm.h"
#include "hardware/clocks.h"
#include "CONFIG.h"

#define PWM_WRAP 65535

void heartbeat_init(void) {
    gpio_set_function(PIN_HEARTBEAT, GPIO_FUNC_PWM);

    uint slice = pwm_gpio_to_slice_num(PIN_HEARTBEAT);
    pwm_config cfg = pwm_get_default_config();

    float divider = (float)clock_get_hz(clk_sys) /
        ((float)HEARTBEAT_PWM_FREQ_HZ * (PWM_WRAP + 1));
    if (divider < 1.0f) divider = 1.0f;

    pwm_config_set_clkdiv(&cfg, divider);
    pwm_config_set_wrap(&cfg, PWM_WRAP);
    pwm_init(slice, &cfg, true);
    pwm_set_chan_level(slice, pwm_gpio_to_channel(PIN_HEARTBEAT), 0);
}

// Set LED brightness: 0 = off, 65535 = full
void heartbeat_set(uint16_t brightness) {
    uint slice = pwm_gpio_to_slice_num(PIN_HEARTBEAT);
    uint channel = pwm_gpio_to_channel(PIN_HEARTBEAT);
    pwm_set_chan_level(slice, channel, brightness);
}
```

13.6 UART (via M.2 Connector)

```
#include "hardware/uart.h"

// Example: UART0 on GPIO0 (TX) and GPIO1 (RX) -- M.2 pins 57 and 55
void uart_example_init(void) {
    uart_init(uart0, 115200);
    gpio_set_function(0, GPIO_FUNC_UART); // UART0 TX
    gpio_set_function(1, GPIO_FUNC_UART); // UART0 RX
}
```

13.7 CMakeLists.txt Template

```
cmake_minimum_required(VERSION 3.13)

set(CMAKE_C_STANDARD 11)
set(CMAKE_CXX_STANDARD 17)
set(CMAKE_EXPORT_COMPILE_COMMANDS ON)

# Pico SDK integration (VS Code extension auto-config)
if(WIN32)
    set(USERHOME $ENV{USERPROFILE})
else()
    set(USERHOME $ENV{HOME})
endif()
set(sdkVersion 2.2.0)
set(toolchainVersion 14_2_Rel1)
```

```
set(picotoolVersion 2.2.0-a4)
set(picoVscode ${USERHOME}/.pico-sdk/cmake/pico-vscode.cmake)
if (EXISTS ${picoVscode})
    include(${picoVscode})
endif()

set(PICO_BOARD pico2 CACHE STRING "Board type")

include(pico_sdk_import.cmake)

project(MyProject C CXX ASM)
pico_sdk_init()

add_executable(MyProject main.c)

pico_set_program_name(MyProject "MyProject")
pico_set_program_version(MyProject "0.1")

# Enable USB output, disable UART output
pico_enable_stdio_uart(MyProject 0)
pico_enable_stdio_usb(MyProject 1)

target_link_libraries(MyProject
    pico_stdlib
    hardware_spi      # For MCP2515 CAN controller
    hardware_i2c      # For EEPROM
    hardware_adc       # For ADC monitoring
    hardware_pwm       # For heartbeat LED
)

target_include_directories(MyProject PRIVATE
    ${CMAKE_CURRENT_LIST_DIR}
)

pico_add_extra_outputs(MyProject)
```

14. Code Examples

14.1 Heartbeat LED (Breathing Effect)

The included `Heartbeat.c` example demonstrates a smooth PWM breathing pattern on the onboard blue LED. See `src/Software/Heartbeat/` for the complete project.

Behavior: The LED linearly fades from off to full brightness and back over approximately 2 seconds (128 steps x 2 directions x 8 ms per step).

14.2 Minimal MCP2515 CAN Initialization

```
#include <stdio.h>
#include "pico/stdlib.h"
#include "hardware/spi.h"
#include "CONFIG.h"

int main(void) {
    stdio_init_all();

    // Initialize SPI1 for MCP2515
    spi_init(CAN_SPI_INSTANCE, CAN_SPI_BAUDRATE);
    gpio_set_function(PIN_CAN_MISO, GPIO_FUNC_SPI);
    gpio_set_function(PIN_CAN_MOSI, GPIO_FUNC_SPI);
    gpio_set_function(PIN_CAN_SCK, GPIO_FUNC_SPI);
```

```

gpio_init(PIN_CAN_CS);
gpio_set_dir(PIN_CAN_CS, GPIO_OUT);
gpio_put(PIN_CAN_CS, 1);

// Hardware reset the MCP2515
gpio_init(PIN_CAN_RST);
gpio_set_dir(PIN_CAN_RST, GPIO_OUT);
gpio_put(PIN_CAN_RST, 0);
sleep_us(10);
gpio_put(PIN_CAN_RST, 1);
sleep_ms(1);

// Software reset (puts MCP2515 into Configuration mode)
uint8_t reset_cmd = 0xC0;
gpio_put(PIN_CAN_CS, 0);
spi_write_blocking(CAN_SPI_INSTANCE, &reset_cmd, 1);
gpio_put(PIN_CAN_CS, 1);
sleep_ms(1);

// Read CANSTAT register (address 0x0E) to verify Configuration mode
uint8_t tx[2] = {0x03, 0x0E}; // READ instruction + CANSTAT address
uint8_t canstat = 0;
gpio_put(PIN_CAN_CS, 0);
spi_write_blocking(CAN_SPI_INSTANCE, tx, 2);
spi_read_blocking(CAN_SPI_INSTANCE, 0x00, &canstat, 1);
gpio_put(PIN_CAN_CS, 1);

printf("MCP2515 CANSTAT: 0x%02X (expected 0x80 = Config mode)\n", canstat);

while (true) {
    tight_loop_contents();
}
}

```

14.3 EEPROM Read/Write Test

```

#include <stdio.h>
#include <string.h>
#include "pico/stdlib.h"
#include "hardware/i2c.h"
#include "CONFIG.h"

int main(void) {
    stdio_init_all();
    sleep_ms(2000); // Wait for USB enumeration

    // Initialize I2C0
    i2c_init(EEPROM_I2C_INSTANCE, EEPROM_I2C_BAUDRATE);
    gpio_set_function(PIN_I2C0_SDA, GPIO_FUNC_I2C);
    gpio_set_function(PIN_I2C0_SCL, GPIO_FUNC_I2C);

    // Write test data to EEPROM address 0x0000
    uint8_t write_buf[] = {0x00, 0x00, 'H', 'e', 'l', 'l', 'o'};
    int ret = i2c_write_blocking(EEPROM_I2C_INSTANCE, EEPROM_I2C_ADDR,
                                write_buf, sizeof(write_buf), false);
    printf("Write returned: %d\n", ret);
    sleep_ms(5); // EEPROM write cycle
}

```

```

// Read back
uint8_t addr_buf[] = {0x00, 0x00};
i2c_write_blocking(EEPROM_I2C_INSTANCE, EEPROM_I2C_ADDR,
                  addr_buf, 2, true);

uint8_t read_buf[5] = {0};
i2c_read_blocking(EEPROM_I2C_INSTANCE, EEPROM_I2C_ADDR,
                 read_buf, 5, false);

printf("Read back: %c%c%c%c%c\n",
       read_buf[0], read_buf[1], read_buf[2],
       read_buf[3], read_buf[4]);

while (true) {
    tight_loop_contents();
}
}

```

14.4 ADC Calibration and VBUS Monitoring

```

#include <stdio.h>
#include "pico/stdlib.h"
#include "hardware/adc.h"
#include "CONFIG.h"

int main(void) {
    stdio_init_all();
    sleep_ms(2000);

    adc_init();
    adc_gpio_init(PIN_ADC_VUSB);
    adc_gpio_init(PIN_ADC_VREF);

    // Calibrate using onboard 3.0V reference
    adc_select_input(7); // ADC7 = GPIO47 (VREF)
    adc_read();         // Throwaway sample after channel switch
    uint16_t ref_raw = adc_read();
    float ref_measured = (float)ref_raw * 3.0f / 4096.0f * 2.0f;
    float cal_factor = 3.0f / ref_measured;

    printf("Reference ADC raw: %u\n", ref_raw);
    printf("Measured: %.3f V (expected 3.000 V)\n", ref_measured);
    printf("Calibration factor: %.4f\n", cal_factor);

    while (true) {
        // Read VBUS
        adc_select_input(6); // ADC6 = GPIO46 (VUSB)
        adc_read();         // Throwaway sample after channel switch
        uint16_t vbus_raw = adc_read();
        float vbus = (float)vbus_raw * 3.0f / 4096.0f * 2.0f * cal_factor;

        printf("VBUS: %.2f V (raw: %u)\n", vbus, vbus_raw);
        sleep_ms(1000);
    }
}

```

15. Design Considerations for Carrier Boards

15.1 CAN Bus Wiring

The carrier board connects the CAN bus signals from the M.2 connector to a bus connector (screw terminal, DB-9, pin header, etc.):

- **CAN_P (CANH):** M.2 pin 28
- **CAN_N (CANL):** M.2 pin 30

Use a twisted pair or close-routed differential pair for the CAN bus traces. Keep stub lengths as short as possible to minimize reflections.

15.2 Power Supply Design

- **5 V mode:** Provide stable 5 V on M.2 pins 14 and 16 (+5V INPUT). Minimum current capacity: 300 mA (to support MCU + MCP2515 + TCAN1044A + peripherals). Recommended: 1 A or more if the carrier board also draws from the 3.3 V output. M.2 pins 10 and 12 provide **3.3 V output** from the onboard LDO (up to 1 A available for carrier board electronics).
- **External 3.3 V mode:** Supply regulated 3.3 V on M.2 pins 10 and 12. The carrier board supplies all current (module draws ~55 mA typical with CAN active).
- Add bulk capacitance (47-100 uF) near the M.2 connector on the carrier board.

15.3 USB Routing

- Route USB_D+ (pin 69) and USB_D- (pin 71) as a 90 Ohm differential pair.
- Keep trace lengths matched.
- Provide VBUS on pins 72, 74, 75 if USB-powered operation is desired.

15.4 I2C Bus Extension

- I2C0 can be used on any M.2-accessible GPIO with the I2C0 alternate function. The onboard EEPROM (GPIO32–33) is not wired to the M.2 connector, so the carrier board operates on a physically separate I2C bus – all addresses including 0x50 are available.
- Total bus capacitance should not exceed 400 pF for reliable 400 kHz operation.

15.5 SPI Bus Sharing

- SPI1 is occupied by the MCP2515 (GPIO28–31, directly on the module).
- SPI0 is fully available on the M.2 connector (multiple GPIO options).
- If using SPI1 on M.2 GPIO pins (GPIO8–15, GPIO25–27, GPIO40–45), make sure the MCP2515 CS (GPIO29) is deasserted (high) to avoid bus contention.

15.6 CAN Bus Termination

- The module includes onboard 120 Ohm split termination (2x 60.4 Ohm).
- If the module is at one end of the CAN bus, onboard termination is sufficient.
- For mid-bus placement, remove the onboard termination resistors (R35, R36) and provide 120 Ohm termination at both physical ends of the bus.
- Maximum recommended bus length depends on bit rate:
 - 1 Mbps: ~25 m
 - 500 kbps: ~100 m
 - 125 kbps: ~500 m

16. Mechanical Specifications

Parameter	Value
Form Factor	M.2 2980 M-Key
Card Dimensions	29 mm x 80 mm
Thickness	~1.6 mm (6-layer PCB)
Edge Connector	M-Key (75 pins)

Parameter	Value
Mating Connector	MDT420E03001 (or equiv)
Mounting	M2.5 threaded standoff
Weight	< 10 g

17. Absolute Maximum Ratings

Exceeding absolute maximum ratings may cause permanent damage to the module.

Parameter	Rating
VIN (5 V input)	-0.3 to 6.0 V
VCC (3.3 V rail)	-0.3 to 3.6 V
GPIO voltage (any pin)	-0.3 to 3.63 V
Maximum GPIO source current	12 mA per pin
Maximum total GPIO current	50 mA
Storage Temperature	-40 to +85 degC
Operating Temperature	-20 to +70 degC
ESD (HBM)	2 kV

Caution: The RP2354B GPIOs are **NOT** 5 V tolerant. All signal levels connected to the M.2 connector must be 3.3 V logic. Use level shifters on the carrier board if interfacing with 5 V systems.

18. Revision History

Revision	Date	Notes
1.0.0	2026-01-31	Initial creation

This document is derived from the BladeCore-M54C schematics (v1.0.0) and associated design files. Component-level limits and behavior should be verified against the respective datasheets. For the latest information, refer to the project repository.

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